FPF2024/25/26/27
Full Functional Load Switch with 100 mA Current Limit

## Features

- 1.6 V to 5.5 V Input Voltage Range
- Ultra Low Average Quiescent Current $1 \mu \mathrm{~A}$ Typical at1.8 V
- Typical $R_{D S(O N)}=225 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathbb{I N}}=3.3 \mathrm{~V}$
- Typical $R_{D S(O N)}=280 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathbb{I N}}=1.8 \mathrm{~V}$
- 100 mA Fixed Current Limit Minimum
- Under-Voltage Lockout (UVLO)
- CMOS and Open Drain Fault Flag Options
- Fault Blanking
- Auto Restart
- Thermal Shutdown
- ESD Protection

$$
\begin{array}{ll}
\circ & >5500 \text { V HBM } \\
\circ & >1500 \text { V CDM }
\end{array}
$$

## Applications

- PDAs
- Cell Phones
- GPS Devices
- Digital Cameras
- Peripheral Ports
- MP3 Players


## Description

The FPF2024/5/6/7 are low $R_{\text {DS(ON) }}$ P-Channel MOSFET load switches with 150 mA typical current limit value targeting small package load switch applications. The extended input voltage range spans from 1.6 V to 5.5 V to fulfill today's ultra-portable device's supply requirements. Switch control is by a logic input (ON) capable of interfacing directly with a low voltage control signal.

The FPF2024/25/26/27 respond to an output overload condition by going into constant current mode where the output current is regulated by the load switch. If the over-current condition persists beyond the 10 ms Blanking Time, the FPF2024 and FPF2025 pull the fault signal pin (FLAGB) low and shut-off the switch. An AutoRestart feature turns the FPF2024 and FPF2025 on again after 70 ms if the ON pin is still active. The FPF2026 has a Latch-Off feature which shuts off the switch off after the expiration of the 10 ms Blanking Time and keeps it off until the ON pin is toggled. The FPF2027 responds to an overload condition by immediately pulling the fault signal pin LOW and the switch remains in constant current mode until the output overload condition is removed. The FPF2027 has a Startup Blanking feature which prevents startup transient over-current conditions from triggering the fault signal pin for 10 ms after initial turn on via the ON pin.
These parts are available in a space-saving 6-ball advanced. Pb-Free $1.0 \times 1.5 \mathrm{~mm}^{2}$ CSP package.


BOTTOM


TOP

Figure 1. 6 -Ball $1.0 \times 1.5 \mathrm{~mm}^{2}$ CSP Package

## Ordering Information

| Part Number | Min. Limit <br> [mA] | Blank Current <br> Limit Time <br> [ms] | Auto-Restart <br> Time [ms] | ON Pin <br> Activity | FLAGB | Top Mark |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FPF2024 | 100 | 10 | 70 | Active HI | Open Drain | S 2 |
| FPF2025 | 100 | 10 | 70 | Active LO | CMOS | S 3 |
| FPF2026 | 100 | 10 | $\mathrm{n} / \mathrm{a}$ | Active HI | Open Drain | S 4 |
| FPF2027 | 100 | 0 | $\mathrm{n} / \mathrm{a}$ | Active HI | Open Drain | S 5 |

## Typical Application



Figure 2. Typical Application

## Block Diagram



Figure 3. Block Diagram

## Pin Configuration

| $\mathrm{V}_{\text {IN }}$ | A2 A1 |
| :---: | :---: |
| NC | 1 |
| ON | C2 C1 |

Figure 4. Pin Assignment $1.0 \times 1.5$ CSP Bottom View

## Pin Description

| Pin | Name | Function |
| :---: | :---: | :--- |
| A1 | $V_{\text {Out }}$ | Switch Output. Output of the power switch. |
| A2 | $V_{\text {IN }}$ | Supply Input. Input to the power switch and the supply voltage for the IC. |
| B1 | GND | Ground. |
| B2 | NC | No Connection. |
| C1 | FLAGB | Fault Output. Active LOW, open drain output for PFPF2024/26/27 and CMOS output for <br> FPF2025. FLAGB indicates an over-current, supply under-voltage or over-temperature state. |
| C2 | ON | ON/OFF Control Input. Active HIGH for FPF2024/26/27 and Active LOW for FPF2025. |

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}$, $\mathrm{V}_{\text {OUt }}$, ON, FLAG, GND |  | -0.3 | 6.0 | V |
| PD | Power Dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}^{(1)}$ |  |  | 1.2 | W |
| Isw | Maximum Continuous Switch Current |  |  | 0.2 | A |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range |  | -40 | 125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Junction Temperature |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\Theta_{\mathrm{JA}}$ | Thermal Resistance, Junction-to-Ambient |  |  | 85 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| ESD | Electrostatic Discharge Capability | Human Body Model |  | 5500 |  |
|  |  | Charged Device Model |  | 1500 |  |

## Note:

1. Package power dissipation on 1 square inch pad, 2 oz. copper board.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathbb{N}}$ | Input Voltage | 1.6 | 5.5 | V |
| $\mathrm{~T}_{\mathrm{A}}$ | Ambient Operating Temperature | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics
Unless otherwise noted, $\mathrm{V}_{\mathbb{I N}}=1.6$ to 5.5 V and $\mathrm{T}_{\mathrm{A}}=-40$ to $+85^{\circ} \mathrm{C}$. Typical values are at $\mathrm{V}_{\mathbb{I N}}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.


## Note:

2. FPF2027 has a 10 ms Startup FLAGB Blanking Time when the part is turned on via ON pin to ensure transient load currents settle down.

Typical Performance Characteristics


Figure 5. Shutdown Current vs. Temperature


Figure 7. Quiescent Current vs. Temperature


Figure 9. $\quad \mathbf{R}_{\mathrm{DS}(\mathrm{ON})} \mathbf{v s}$. $\mathrm{V}_{\mathrm{IN}}$


Figure 6. $\quad T_{\text {Restart }}$ vs. Temperature


Figure 8. $\quad \mathrm{T}_{\text {Blank }}$ vs. Temperature


Figure 10. $\quad \mathbf{R}_{\mathrm{DS}(\mathrm{ON})}$ vs. Temperature

Typical Performance Characteristics (Continued)


Figure 11. ILimit vs. $\mathrm{V}_{\mathrm{IN}}$


Figure 13. $\quad \mathrm{V}_{\mathrm{IH}}, \mathrm{V}_{\mathrm{IL}}$ vs. Temperature


Figure 15. FPF2024 toff Response


Figure 12. LLimit vs. Temperature


Figure 14. FPF2024 ton Response


Figure 16. FPF2024 Tblank Response ${ }^{(3)}$

Typical Performance Characteristics (Continued)


Figure 17. FPF2024 Trestart Response ${ }^{(3)}$


Figure 19. FPF2024 Current Limit Response Time
(Output is loaded by $5 \Omega$ and $C_{\text {out }}=100 \mu \mathrm{~F}$ )


Figure 21. FPF2024 Current Limit Response (Input and enable pin are tied together and Vout is shorted to GND)


Figure 18. FPF2024 Current Limit Response Time (Output is loaded by $5 \Omega$ and $C_{\text {out }}=10 \mu \mathrm{~F}$ )


Figure 20. FPF2024 Short Circuit Response Time (Output shorted to GND while the switch is in normal operation)


Figure 22. FPF2027 Over-Current ${ }^{(3)}$
Over-Current condition is applied while device in normal operation (FLAGB inserts immediately and reports the fault condition)

## Typical Performance Characteristics (Continued)



Figure 23. FPF2027 Startup FLAGB Blanking Time


Figure 24. FPF2025 Tblank and Trestart (Active LO Device)

## Note:

3. $V_{\text {DRV }}$ signal forces the device to go into over-current condition by loading a $7.5 \Omega$.

## Description of Operation

FPF2024-FPF2027 series Full-Function switches are current limited load switches with ultra-low power consumption. The core of each device consists of a 230 mW P-channel MOSFET featuring slow turn-on to limit the inrush current, fast turn-off, current limit, UnderVoltage Lockout (UVLO) and thermal shutdown protection features and a FLAGB output that indicates that a fault condition has occurred.

Some versions in the FPF202x series also feature Current Limit Blanking and Auto-Restart.

The FPF202x family achieves an ultra-low current consumption of $1 \mu \mathrm{~A}$ through a proprietary "Sleep and Wake-up Modes" implementation. Full functionality is guaranteed for operating voltages down to 1.6 V over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.

## Sleep and Wakeup Mode Description

The ultra-low power consumption of FPF2024-FPF2027 is achieved through the implementation of proprietary Sleep/ Wakeup modes.
The FPF2024-FPF2027 family turns on in Startup mode where it checks for potential load current, temperature, and under-voltage faults for 10 ms . If no faults are detected during this startup period, the FPF2024FPF2027 goes into a Sleep mode where it stays for 257 ms . At the end of the Sleep period, the part goes into Wakeup mode to check for any fault condition. If no fault is detected in 1 ms , the part goes back to Sleep mode. The 1:257 Wakeup/Sleep duty cycle results in an overall average current consumption of $1 \mu \mathrm{~A}$ (typical).

During Sleep mode the thermal and under-voltage conditions are not monitored to reduce the current consumption of the device.

The switch current limiting circuitry is active at all times and protects the FPF2024-FPF2027 against excessive load currents in all modes. While in the Wakeup mode, a current fault event will prevent the part from reentering into Sleep mode even if input voltage and temperature faults are not present. In such a case, the part functions according to its feature set, e.g., it performs its normal Blanking, Auto-Restart or Latch-off functions as expected. If the over-current condition is removed from the output, the part will go back into Sleep mode after 10 ms . The representative state diagrams of the FPF2024-FPF2027 are given in Figure 25, Figure 26 and Figure 27.
The ultra-low quiescent current consumption of $1 \mu \mathrm{~A}$ along with the very-low minimum operating voltage of 1.6 V, make the FPF2024-FPF2027 an ideal fullfunction load switch for ultraportable applications.

## On/Off Control

The ON pin controls the state of the switch. The FPF2024- FPF2027 series features both active high and low configurations to accommodate various application requirements. FPF2024, FPF2026 and FPF2027 are active high switches while the FPF2025 is an active low device. Applying a continuous high or low signal depending on the switch configuration, will hold the switch in the ON state. The load switch will move into
the OFF state when the ON pin is inactive. In addition, FPF2026 moves into the OFF state if a current fault is encountered for longer duration than the Blanking Time. For all versions, an under-voltage on $\mathrm{V}_{\mathrm{IN}}$ or a junction temperature in excess of $140^{\circ} \mathrm{C}$ overrides the ON control and turns off the switch.

In addition, a current fault condition longer than the Blanking Time will cause the switch to turn off in the FPF2024, FPF2025 and FPF2026. The FPF2024 and FPF2025 have an Auto-Restart feature which will automatically turn the switch on again after 70 ms . For the FPF2026, the ON pin must be toggled to turn the switch on again. The FPF2027 does not turn off in response to an over-current condition, and remains in a constant current mode for so long as the ON pin is active, and the thermal shutdown or UVLO are not activated.

The ON pin control voltage and VIN pin have independent recommended operating ranges. The ON pin voltage can be driven by a voltage level higher than the input voltage.

## Fault Reporting

Over-current, input under-voltage, or over-temperature fault conditions are signaled out by the FLAGB pin going low. FPF2024, FPF2025 and FPF2026 have a current fault blanking feature which prevents current faults lasting shorter than the Blanking Time of 10 ms (typical) from triggering the fault signal (FLAGB) output.
If the over-current condition persists beyond the Blanking Time, the FPF2024 and FPF2025 pull the FLAGB pin low and shut the switch off. If the ON pin is kept active, an Auto-Restart feature releases the FLAGB pin and turns the switch on again after 70 ms .

If the over-current condition persists beyond the Blanking Time, the FPF2026 has a Latch-Off feature which pulls the FLAGB pin low and shuts the switch off. The switch is kept off and the FLAGB pin is kept low until the ON pin is toggled.

The FPF2027 responds to an overload condition by immediately pulling the FLAGB pin low and the switch remains in constant current mode until the output overload condition is removed. The FPF2027 has a Startup Blanking feature which prevents current faults related to startup transients from triggering the FLAGB output. The Startup Blanking feature is effective for the first 10 ms (typical) following device turn-on via ON pin.

The FPF2024, FPF2026 and FPF2027 have an opendrain MOSFET FLAGB output which requires a pull-up resistor between VIN and FLAGB. A $100 \mathrm{~K} \Omega$ pull up resistor is recommended. The FPF2025 has a CMOS FLAGB output and does not require a pull-up resistor. During shutdown, the pull-down on FLAGB is disabled to reduce current draw from the supply.

## Current Limiting

The current limit function ensures that the current through the switch does not exceed a maximum value while not limiting at less than a minimum value. The minimum current at which the parts will limit the load current is internally set to 100 mA .

The switch current limiting circuitry is active at all times (Sleep and Wakeup mode) and protects the FPF2024FPF2027 against excessive load currents in all modes. The proprietary current limiting circuit responds to an over-current condition in $15 \mu \mathrm{~s}$ (typical).

## Under-Voltage Lockout (UVLO)

The under-voltage lockout feature turns-off the switch if the input voltage drops below the under-voltage lockout threshold. With the ON pin active, the input voltage rising above the under-voltage lockout threshold will cause a controlled turn-on of the switch and will limit current over-shoots. The UVLO feature is disabled during Sleep mode. If device is in the UVLO condition, FLAGB goes low and indicates the fault. If the input voltage goes below UVLO voltage but remains above 1.3 V (typical) during Sleep mode, the switch is kept on until the next Wakeup cycle, where the UVLO violation will be detected. If the input voltage falls below 1.3 V in Sleep mode, the switch is immediately turned off.

## Thermal Shutdown

The Thermal Shutdown protects the device from internally or externally generated excessive temperatures. The Thermal shutdown feature is disabled during Sleep mode. However, excessive load currents that may result in high power dissipation will be detected during Sleep mode and will activate the full function Wakeup mode, which has thermal shutdown protection. During an over-temperature condition the FLAGB is pulled low and the switch is turned-off. If the temperature of the die drops below the threshold temperature, the switch automatically turns on again, To avoid unwanted thermal oscillations, a $10^{\circ} \mathrm{C}$ (typical) thermal hysteresis is implemented between thermal shutdown entry and exit temperatures.


Figure 26. State Diagram with Blanking Only (No Auto-Restart FPF2026)


Figure 27. State Diagram with No Blanking (FPF2027)

## Application Information

## Input Capacitor

To limit the voltage drop on the input supply caused by transient in-rush currents when the switch is turned on into a discharged load capacitor or a short-circuit, a capacitor is recommended to be placed between VIN and GND. The FPF2024-FPF2027 series feature a slow turn-on to limit the inrush current and requires a smaller input capacitor. A $1 \mu \mathrm{~F}$ ceramic capacitor, CIN, placed close to the pins is typically sufficient. Higher values of Cin can be used to further reduce the voltage drop.

## Output Capacitor

A $0.1 \mu \mathrm{~F}$ capacitor $\mathrm{C}_{\text {out, }}$ should be placed between $V_{\text {OUt }}$ and GND. This capacitor will prevent parasitic board inductances from forcing $\mathrm{V}_{\text {Out }}$ below GND when the switch turns-off. For the FPF2024, FPF2025 and FPF2026, the total output capacitance needs to be kept below a maximum value, Cout(max), to prevent the part from registering an over-current condition beyond the Blanking Time and turning-off the switch. The maximum output capacitance can be determined from the following formula:

$$
\begin{equation*}
\mathrm{C}_{\text {OUT(MAX) }}=\frac{\mathrm{I}_{\text {LIM(MAX) }} \times \mathrm{t}_{\text {BLANK(MIN) }}}{\mathrm{V}_{\mathrm{IN}}} \tag{1}
\end{equation*}
$$

## Power Dissipation

During normal operation as a switch, the power dissipation is small and has little effect on the operating temperature of the part. The maximum power dissipation while switch is in normal operation occurs just before a part enters the current limit. This may be calculated using the formula bellow:

$$
\begin{align*}
\mathrm{P}_{\text {MAX (NORMAL OPERATION }}
\end{align*}
$$

If the part goes into current limit, the maximum power dissipation occurs when the output of switch is shorted to ground. For the FPF2024 and FPF2025, the power dissipation will scale with the Auto-Restart Time, thstrt, and the Over Current Blanking Time, tblank. In this case the maximum power dissipated for the FPF2024 and FPF2025 is:

$$
\begin{align*}
& \mathrm{p}_{\text {MAX (Current Limit })}=\frac{\mathrm{t}_{\text {BLANK }}}{\mathrm{t}_{\text {BLANK }}+\mathrm{t}_{\mathrm{RSTRT}}} \times \mathrm{V}_{\text {IN }(\mathrm{MAX})} \times  \tag{3}\\
& \mathrm{I}_{\mathrm{LIM}(\mathrm{MAX})}=\frac{10}{10+70} \times 5.5 \times 0.2=137 \mathrm{~mW}
\end{align*}
$$

Take note that this is below the maximum package power dissipation, and the thermal shutdown feature protection provides additional safety to protect the part from damage due to excessive heating. The junction temperature is only able to increase to the thermal shutdown threshold. Once this temperature has been reached, toggling ON will have no effect until the junction temperature drops below the thermal shutdown exit temperature. For the FPF2027, a short on the output will cause the part to operate in a constant current state dissipating a worst case power of:

$$
\begin{equation*}
\mathrm{P}_{\mathrm{MAX}}=\mathrm{V}_{\mathrm{IN}(\mathrm{MAX})} \times \mathrm{I}_{\mathrm{LIM}(\mathrm{MAX})}=5.5 \times 0.2=1.1 \mathrm{~W} \tag{4}
\end{equation*}
$$

This power dissipation is significant enough that it will activate the thermal shutdown protection, and the part will cycle in and out of thermal shutdown so long as the ON pin is active and the output short is present.

## Improving Thermal Performance

An improper layout could result in higher junction temperature and ultimately trigger the thermal shutdown protection feature. This concern applies particularly significant for the FPF2027 where the switch is in constant current mode in the overload conditions.

The following techniques have been identified to improve the thermal performance of this family of devices. These techniques are listed in order of the significance of their impact.

- NC pin can be connected to the GND plane to improve thermal performance.
- The VIn, Vout and GND pins will dissipate most of the heat generated during a high load current condition. Using wide traces will help minimize parasitic electrical effects, along with minimizing the case to ambient thermal impedance. The layout suggested in Figure 28 provides each pin with adequate copper so that heat may be transferred out of the device as efficiently as possible. The lowpower FLAGB and ON pin traces may be laid-out to maximize the area available to the ground pad.
- Placing the input and output capacitors as close to the device as possible also contributes to heat dissipation, particularly during high load currents.


## FPF202X Demo Board

FPF202X Demo board has components and circuitry to demonstrate the functions and features of the FPF202X load switch family. An N-Channel MOSFET(Q), in series with a $7.5 \Omega$ resistor, are connected between Vout and the GND pin of the device. By turning on the Q transistor, the $7.5 \Omega$ is loaded to the output voltage and simulates an over-current condition. The R2 resistor is connected between FLAGB pin and input voltage as pull-up resistor for FPF2024, FPF2026 and FPF2027 devices. The FPF2025 does not require a pull-up resistor due to its CMOS output structure.
The thermal performance of the board is improved using the techniques recommended in the layout recommendations section of datasheet.


Figure 28. FPF2020X Proper Layout
www fa


Figure 29. Top Layer


Figure 31. $\quad$ SST


Figure 30. Bottom Layer


Figure 32. TOP, SST and SMT

The information below pertains to the WLCSP outline drawing on the following page.

## Product Specifications

| Product | D | E | $\mathbf{X}$ | $\mathbf{Y}$ |
| :---: | :---: | :---: | :---: | :---: |
| FPF2024/5/6/7 | $1.500 \pm 0.030$ | $1.000 \pm 0.030$ | 0.240 | 0.240 |



TOP VIEW


RECOMMENDED LAND PATTERN (NSMD PAD TYPE)


SIDE VIEWS

## NOTES:

A. NO JEDEC REGISTRATION APPLIES.


BOTTOM VIEW
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS $\pm 43$ MICRONS (539-625 MICRONS).
F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
G. DRAWING FILNAME: MKT-UC006AFrev3.


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